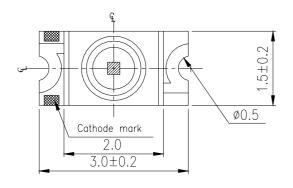
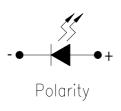
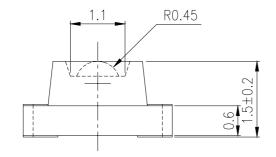


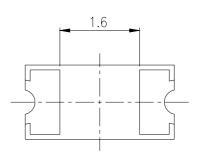
Package Outline Dimensions

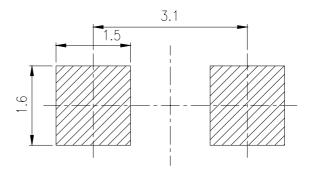






For reflow soldering (propose)





Notes: Tolerances Unless Dimension ± 0.1 mm, Unit = mm

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11-21SDRC/S530-XX/TR8

Absolute Maximum Ratings (Ta=25°C)

Parameter	Symbol	Rating	Unit	
Reverse Voltage	VR	5	V	
Forward Current	IF	25	mA	
Operating Temperature	Topr	-40 ~ +85	${\mathbb C}$	
Storage Temperature	Tstg	-40~ +90	${\mathbb C}$	
Electrostatic Discharge(HBM)	ESD	2000	V	
Power Dissipation	Pd	60	mW	
Peak Forward Current (Duty 1/10 @1KHz)	Ĭf	60	mA	
Soldering Temperature	Tsol	Reflow Soldering : 260 °C for 10 sec. Hand Soldering : 350 °C for 3 sec.		

Electro-Optical Characteristics (Ta=25°C)

Parameter	Symbol	*Chip Rank	Min.	Тур.	Max.	Unit	Condition
Luminous Intensity	Iv	A2	28	50		mcd deg nm nm	- IF=20mA
		A3	40	62			
		A4	50	76			
		A5	63	114			
		A6	80	138			
Viewing Angle	2 \theta 1/2			60			
Peak Wavelength	λр			650			
Dominant Wavelength	λd			639			
Spectrum Radiation Bandwidth	Δλ			20		nm	
Forward Voltage	VF		1.7	2.0	2.4	V	
Reverse Current	Ir				10	μ A	V _R =5V

*11-21SDRC/S530<u>-XX/</u>TR8

└->Chip Rank

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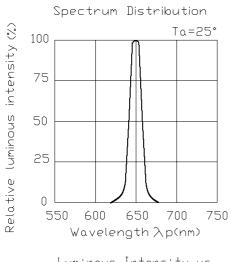
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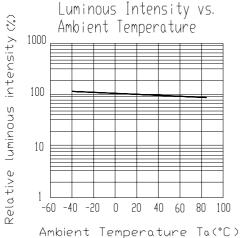
Device No:SZDSE-111-010

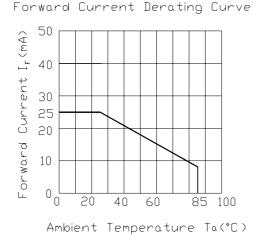
Prepared date: 17-May-2006

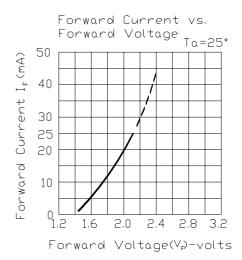


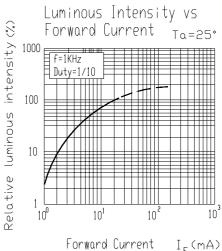
Typical Electro-Optical Characteristics Curves

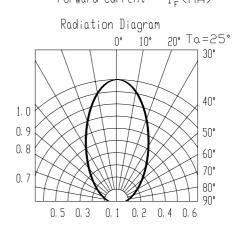












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Label explanation

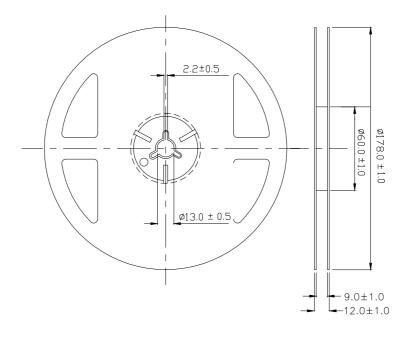
CAT: Luminous Intensity Rank

HUE: Dom. Wavelength Rank

REF: Forward Voltage Rank



Reel Dimensions



Note: The tolerances unless mentioned are ± 0.1 , Unit = mm.

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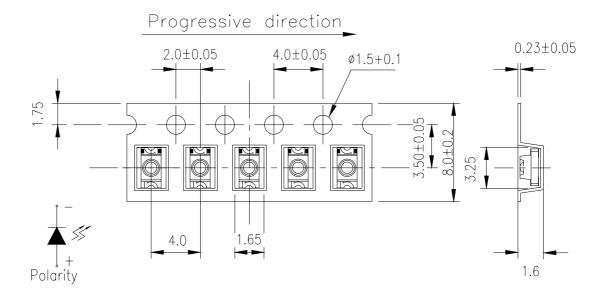
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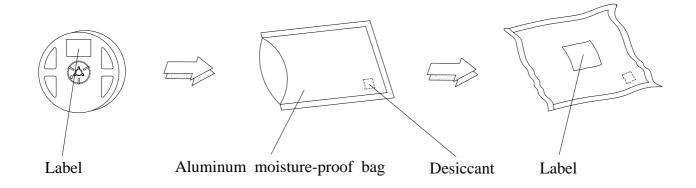


Carrier Tape Dimensions: Loaded quantity 2000 PCS per reel



Note: The tolerances unless mentioned are ± 0.1 , Unit = mm.

Moisture Resistant Packaging



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Reliability Test Items And Conditions

The reliability of products shall be satisfied with items listed below.

Confidence level: 90 %

LTPD: 10 %

No.	Items	Test Condition	Test Hours/Cycles	Sample Size	Ac/Rc
1	Solder Heat	Temp. : 260°C±5°C	6 Sec.	22 PCS.	0/1
2	Temperature Cycle	H:+100°C 30min ∫ 5 min L:-55°C 30min	300 Cycles	22 PCS.	0/1
3	Thermal Shock	H:+100°C 5min ∫ 10 sec L:-10°C 5min	300 Cycles	22 PCS.	0/1
4	High Temperature Storage	Temp. : 100°C	1000 Hrs.	22 PCS.	0/1
5	Low Temperature Storage	Temp. : - 40° C	1000 Hrs.	22 PCS.	0/1
6	DC Operating Life	IF = 20 mA	1000 Hrs.	22 PCS.	0/1
7	High Temperature / High Humidity	85°C/85% RH	1000 Hrs.	22 PCS.	0/1

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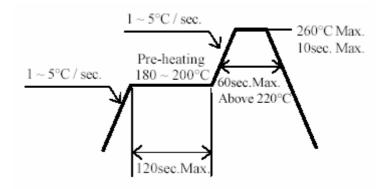
Precautions For Use

1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

- 2. Storage
- 2.1 Do not open moisture proof bag before the products are ready to use.
- 2.2 Before opening the package, the LEDs should be kept at 30°C or less and 90%RH or less.
- 2.3 After opening the package: The LED's floor life is 1 year under 30 deg C or less and 60% RH or less. If unused LEDs remain, it should be stored in moisture proof packages.
- 2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

 Baking treatment: 60±5°C for 24 hours.
- 3. Soldering Condition
- 3.1 Pb-free solder temperature profile



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

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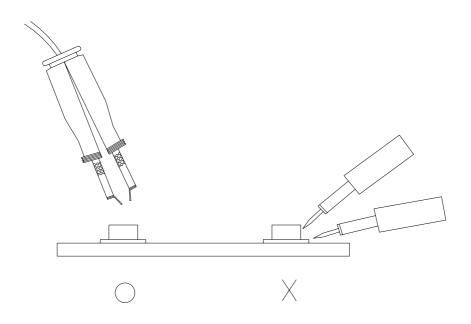


4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350° C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



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